COMPLIANT



### Vishay Semiconductors

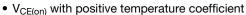
## Half Bridge IGBT Power Module, 600 V, 100 A



PRIMARY CHARACTERISTICS					
V <sub>CES</sub> 600 V					
$I_C$ at $T_C$ = 80 °C	100 A				
$V_{CE(on)}$ (typical) at $I_C = 100$ A, 25 °C	1.65 V				
Speed	8 kHz to 30 kHz				
Package	INT-A-PAK				
Circuit configuration	Half bridge				

#### **FEATURES**

- Low V<sub>CE(on)</sub> trench IGBT technology
- 5 µs short circuit capability



- Maximum junction temperature 175 °C
- · Low inductance case
- · Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (direct copper bonding) technology
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **TYPICAL APPLICATIONS**

- UPS (uninterruptable power supply)
- Switching mode power supplies
- · Electronic welders

#### **DESCRIPTION**

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as UPS and SMPS.

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V <sub>CES</sub>		600	V	
Gate to emitter voltage	V <sub>GES</sub>		± 20	V	
Collector current		T <sub>C</sub> = 25 °C	160		
Collector current I <sub>C</sub>	T <sub>C</sub> = 80 °C	100			
Pulsed collector current	I <sub>CM</sub> <sup>(1)</sup>	t <sub>p</sub> = 1 ms	200	Α	
Diode continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 80 °C	100		
Diode maximum forward current	I <sub>FM</sub> <sup>(1)</sup>	t <sub>p</sub> = 1 ms	200		
Maximum power dissipation	P <sub>D</sub>	T <sub>J</sub> = 175 °C	417	W	
Short circuit withstand time	t <sub>SC</sub>	T <sub>C</sub> = 125 °C	5	μs	
RMS isolation voltage	V <sub>ISOL</sub>	f = 50 Hz, t = 1 min	4000	V	

#### Note

<sup>(1)</sup> Repetitive rating: pulse width limited by maximum junction temperature

IGBT ELECTRICAL SPECIFICATIONS (T <sub>C</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V <sub>(BR)CES</sub>	T <sub>J</sub> = 25 °C	600	-	-	
Callector to amittar valtage	V	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A, T <sub>J</sub> = 25 °C	-	1.65	2.10	v
Collector to emitter voltage	V <sub>CE(on)</sub>	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A, T <sub>J</sub> = 175 °C	-	2.00	-	\ \
Gate to emitter threshold voltage	V <sub>GE(th)</sub>	$V_{CE} = V_{GE}$ , $I_C = 1.0$ mA, $T_J = 25$ °C	4.0	4.4	6.5	
Collector cut-off current	I <sub>CES</sub>	$V_{CE} = V_{CES}$ , $V_{GE} = 0$ V, $T_{J} = 25$ °C	-	-	5.0	mA
Gate to emitter leakage current	I <sub>GES</sub>	$V_{GE} = V_{GES}$ , $V_{CE} = 0$ V, $T_{J} = 25$ °C	-	-	400	nA



SWITCHING CHARACTERISTICS	3					
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	t <sub>d(on)</sub>		-	106	-	ns ns
Rise time	t <sub>r</sub>	1	-	49	-	
Turn-off delay time	t <sub>d(off)</sub>	$V_{CC} = 300 \text{ V}, I_C = 100 \text{ A}, R_g = 2.2 \Omega,$	-	102	-	
Fall time	t <sub>f</sub>	V <sub>GE</sub> = ± 15 V, T <sub>J</sub> = 25 °C	-	85	-	
Turn-on switching loss	E <sub>on</sub>	1	-	0.46	-	
Turn-off switching loss	E <sub>off</sub>	7	-	0.95	-	- mJ
Turn-on delay time	t <sub>d(on)</sub>	$V_{CC} = 300 \text{ V, } I_{C} = 100 \text{ A, } R_{g} = 2.2 \Omega,$ $V_{GE} = \pm 15 \text{ V, } T_{J} = 125 ^{\circ}\text{C}$	-	112	-	ns ns
Rise time	t <sub>r</sub>		-	62	-	
Turn-off delay time	t <sub>d(off)</sub>		-	126	-	
Fall time	t <sub>f</sub>		-	109	-	
Turn-on switching loss	E <sub>on</sub>		-	0.78	-	- mJ
Turn-off switching loss	E <sub>off</sub>	1	-	1.73	-	IIIJ
Input capacitance	C <sub>ies</sub>		-	7.71	-	
Output capacitance	C <sub>oes</sub>	$V_{GE} = 0 \text{ V}, V_{CE} = 30 \text{ V}, f = 1.0 \text{ MHz}$	-	0.53	-	nF
Reverse transfer capacitance	C <sub>res</sub>	1	-	0.23	-	
SC data	I <sub>SC</sub>	$t_p \leq 5~\mu s,~V_{GE} = 15~V,~T_J = 125~^{\circ}C,\\ V_{CC} = 360~V,~V_{CEM} \leq 1200~V$	-	900	-	Α
Stray inductance	L <sub>CE</sub>		-	-	30	nΗ
Module lead resistance, terminal to chip	R <sub>CC'+EE'</sub>		-	0.75	-	mΩ

<b>DIODE ELECTRICAL SPECIFICATIONS</b> (T <sub>C</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Forward voltage	$V_{F}$	I <sub>F</sub> = 100 A	$T_J = 25  ^{\circ}C$	-	1.40	1.80	V
1 orward voitage	VF		T <sub>J</sub> = 125 °C	-	1.40	ı	
Poverse receivery charge	Q <sub>rr</sub>		$T_J = 25  ^{\circ}C$	-	5.5	-	
Reverse recovery charge			T <sub>J</sub> = 125 °C	-	7.3	-	μC
Dook reverse receivers current	I <sub>rr</sub>	$I_F = 100 \text{ A}, V_R = 600 \text{ V}, \\ R_G = 5.6 \Omega \\ V_{GE} = -15 \text{ V}$	T <sub>J</sub> = 25 °C	-	68	-	Α
Peak reverse recovery current			T <sub>J</sub> = 125 °C	-	88	-	A
Daylawa waxayan anaway	_		T <sub>J</sub> = 25 °C	-	0.89	-	m l
Reverse recovery energy	E <sub>rec</sub>		T <sub>J</sub> = 125 °C	-	1.71	-	mJ

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction temperature		TJ		-	-	175	°C
Storage temperature range		T <sub>Stg</sub>		-40	-	125	
Junction to case	IGBT	_		-	-	0.36	
Junction to case	Diode	$R_{thJC}$		-	-	0.57	K/W
Case to sink (conductive grease	applied)	R <sub>thCS</sub>		-	0.05	-	
Mounting torque			Power terminal screw: M5	2.5 to 5.0		Nm	
			Mounting screw: M6	;	3.0 to 5.0	)	INIII
Weight				-	150	-	g



#### www.vishay.com

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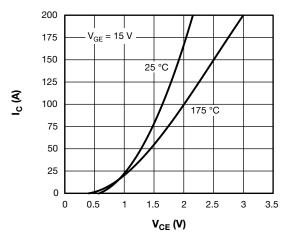


Fig. 1 - IGBT Typical Output Characteristics

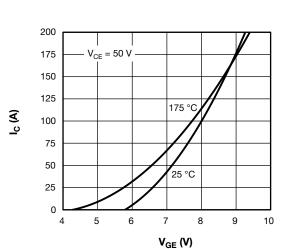


Fig. 2 - IGBT Transfer Characteristics

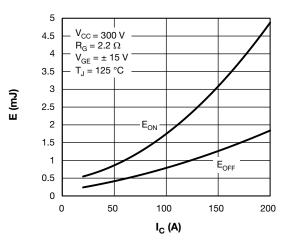


Fig. 3 - IGBT Switching Loss vs. I<sub>C</sub>

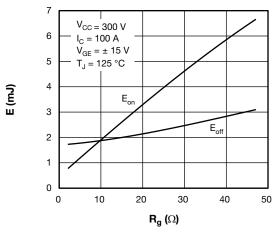


Fig. 4 - IGBT Switching Loss vs. R<sub>G</sub>

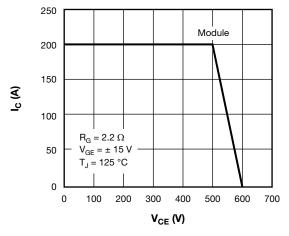


Fig. 5 - RBSOA

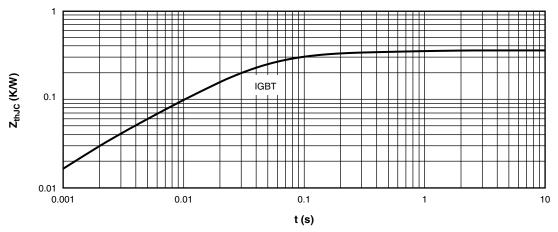
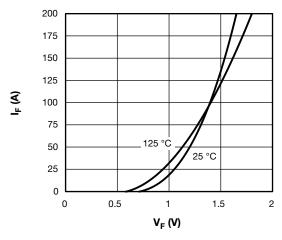


Fig. 6 - IGBT Transient Thermal Impedance





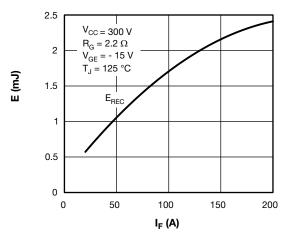


Fig. 8 - Diode Switching Loss vs. I<sub>F</sub>

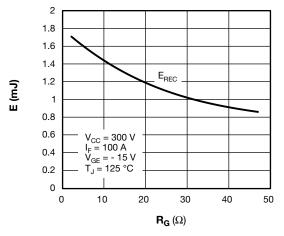


Fig. 9 - Diode Switching Loss vs.  $R_{\mbox{\scriptsize G}}$ 

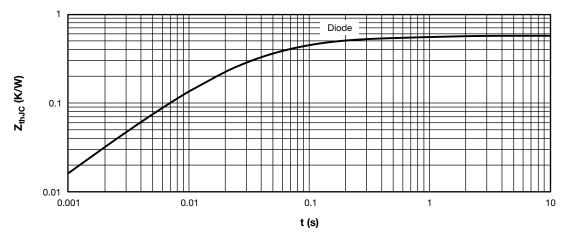
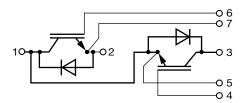


Fig. 10 - Forward Characteristics of Diode

### **CIRCUIT CONFIGURATION**

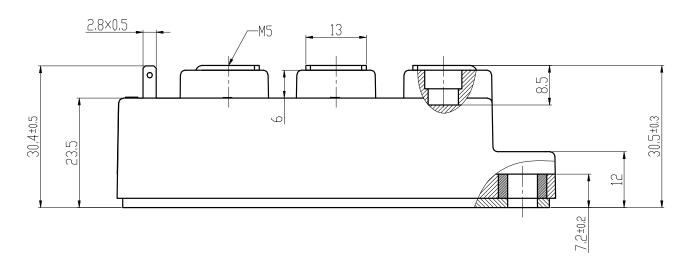


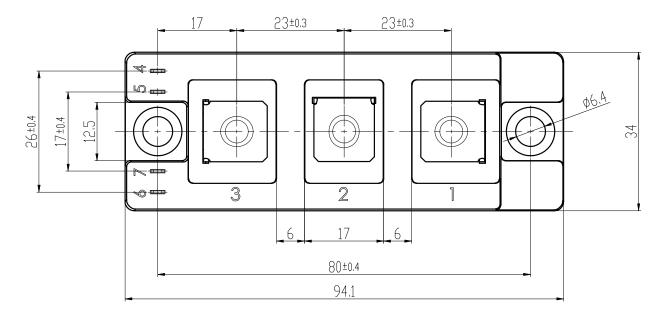
LINKS TO RELAT	ED DOCUMENTS
Dimensions	www.vishay.com/doc?95524



### **INT-A-PAK**

### **DIMENSIONS** in millimeters (inches)







## **Legal Disclaimer Notice**

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